TXC CORPORATION

5F, NO. 16, Sec. 2 Chung Yang S Rd., Peitou, Taipei, Taiwan.

TEL : 886-2-2894-1202 , 886-2-2895-2201 FAX : 886-2-2894-1206 , 886-2-2895-6207 www.txccorp.com

SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE	:	SMD GLASS SEALING X'TAL 3.2*2.5
NOMINAL FREQ.	:	30.000000MHz
TXC P/N	:	7V30000001
REVISION	:	S3
CUSTOMER P/N	:	
PM / SALES	:	
DATE	:	

CUSTOMER SIGNATURE & Date

(1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.

(2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.

(3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.

(4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

Attachment: Product Specification Sheet

1
2
3
4
5

RoHS Compliant

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PRODUCT SPECIFICATION SHEET

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TXC P/N	:	7V30000001
REVISION	:	S3

PE/RD	QA	MFG
		
11-Jul-08		

NOTE:

(1)Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).

(2)Revision "Sx" is for engineering samples only. PE/RD's approval required.

(3)Revision "Ax" is production ready. PE, QA and MFG's approval required.

RoHS Compliant

Rev	Revise page	Revise contents	Date	Ref.No.	Reviser
S1	N/A	Initial released	29-Sep-07	N/A	Xiaoyan Jiang
S2	3	Drawing change	11-Jan-08	N/A	Jeremy
S3	6	Delete Gross Leak&Fine Leak	11-Jul-08	N/A	Xiaoyan Jiang

■ ELECTRICAL SPECIFICATIONS

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : 25±5℃
Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : 25±3℃
Relative humidity : 40%~70%

Measure equipment

Electrical characteristics measured by HP E5100A or equivalent.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

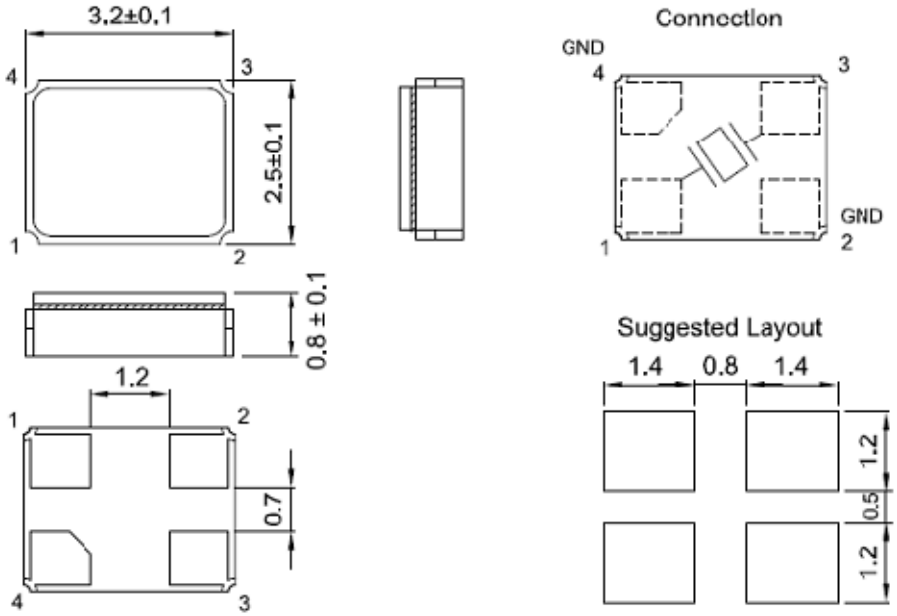
Unit Weight:

0.018±0.001 g/pcs

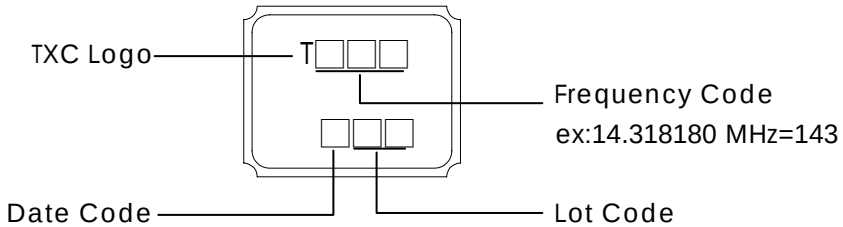
	Parameters	SYM.	Electrical Spec.				Notes
			MIN	TYPE	MAX	UNITS	
1	Nominal Frequency	FL		30.000000		MHz	-
2	Oscillation Mode	-		Fundamental		-	-
3	Load Capacitance	CL		20		pF	-
4	Frequency Tolerance	-		±30		ppm	at 25 ℃ ± 3 ℃
5	Frequency Tolerance	-		±30		ppm	Over Operating Temp. Range (Reference 25℃)
6	Operating Temperature	-	-20	~	70	℃	-
7	Aging	-		±3		ppm	1st Year
8	Drive Level	DL	-	10	-	uW	-
9	Series Resonant Resistance	Rr	-	-	50	Ω	-
10	Shunt Capacitance	C0	0	-	3	pF	-
11	Motional Capacitance (C1)	C1	-	3.3	-	fF	
12	Motional Inductance (L1)	L1	-	8.5	-	mH	
13	Insulation Resistance	-	500	-	-	MΩ	at DC 100V
14	Storage Temperature Range	-	-40	~	85	℃	-

■ DIMENSIONS

UNIT:mm



■ MARKING



Date Code

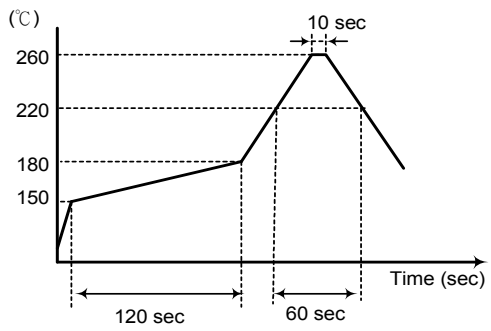
YEAR \ MONTH	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2001 2005 2009 2013 2017	A	B	C	D	E	F	G	H	J	K	L	M
2002 2006 2010 2014 2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2003 2007 2011 2015 2019	a	b	c	d	e	f	g	h	j	k	l	m
2004 2008 2012 2016 2020	n	p	q	r	s	t	u	v	w	x	y	z

This date code will be cycled every four years

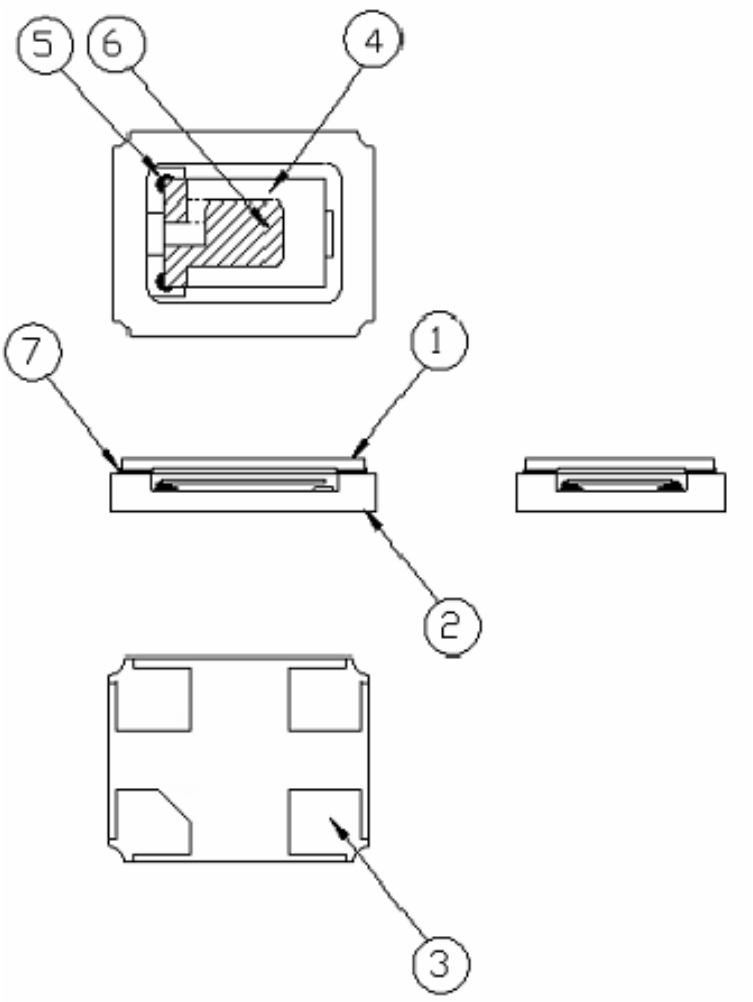
■ SUGGESTED REFLOW PROFILE

Total time : 200 sec. Max.

Solder melting point :220 ℃

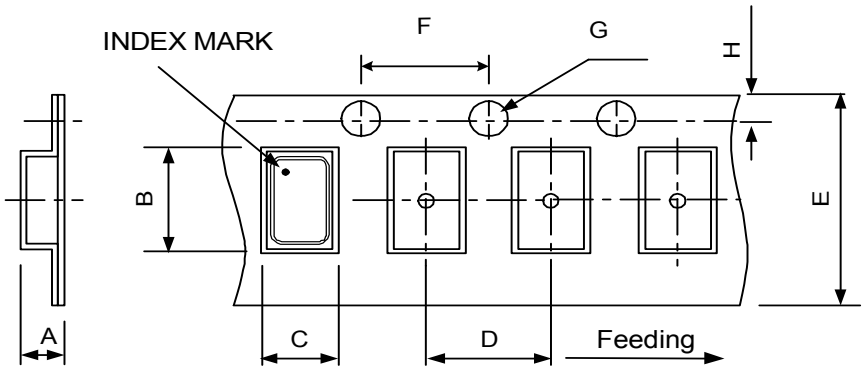


■ STRUCTURE ILLUSTRATION



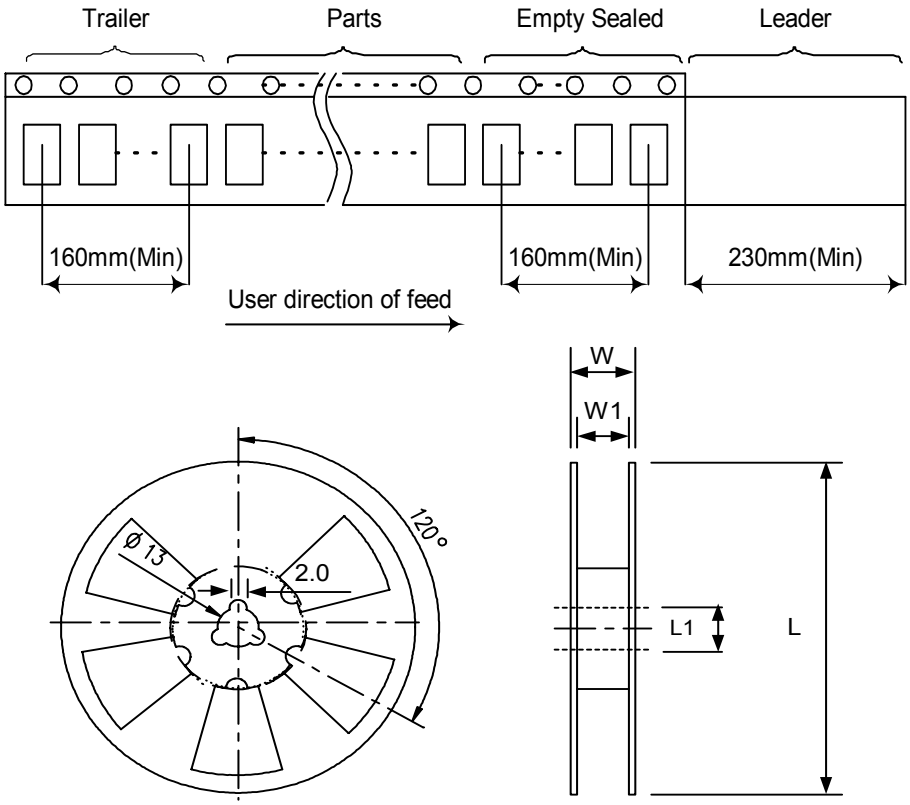
NO	COMPONENTS	MATERIALS	QTY	FINISH/SPECIFICATIONS
1	Cap	Ceramic	1	Color black
2	Package	Ceramic	1	Color black
3	PAD	Au	4	Tungsten metalize + Ni plating + Au plating
4	Crystal blank	SiO2	1	-
5	Conductive adhesive	Ag	4	Silicon resin
6	Electrode	Ag + Cr	2	-
7	Glass	-	-	-

■ PACKING : (EIA-481-2)



DIMENSIONS	A	B	C	D	E	F	G	H	
	1.40	3.40	2.70	4.00	8.00	4.00	1.50	1.75	(UNIT : mm)

REMARK :



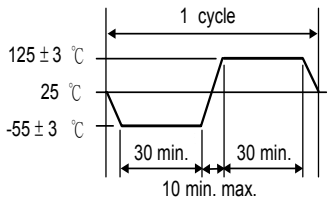
DIMENSIONS	L	L1	W	W1	pcs / Reel (UNIT : mm)
	178	13	11.5	8	Standard Reel Quantity is 3,000 pcs per reel

■ RELIABILITY SPECIFICATIONS

1.Mechanical Endurance

No.	Test Item	Test Methods	CRITIREA	REF.DOC
1.1	Drop Test	100 cm height, 10 times on concrete floor.	△F/F<+/-5ppm △CI<+/-5 Ohm	JIS C6701
1.2	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutually perpendicular axes each 3 times. 0.5m sec. duration time	△F/F<+/-5ppm △CI<+/-5 Ohm	MIL-STD-202F
1.3	Vibration	Frequency range 10 ~ 2000 Hz Amplitude 1.52 mm/20G Sweep time 20 minute Perpendicular axes each test tim 4 hours (Total test time 12 hours)	△F/F<+/-5ppm △CI<+/-5 Ohm	MIL-STD-883E
1.4	Gross Leak	Standard Sample For Automatic Gross Leak Detector, Test Pressure: 2Kg / cm^2	Leak rate < $5*10^{-5}$ Pa m^3／sec	MIL-STD-883E
1.5	Fine Leak	Helium Bombing 4.5 Kg/ cm^2 for 2 hr	Leak rate<10^{-10}Pa m^3／sec at 0.2L	
1.6	Solder ability	Temperature 240 ℃ ± 5℃ Immersing depth 0.5 mm minimum Immersion time 5 ± 1 seconds Flux Rosin resin methyl alcohol solvent (1 : 4)	Check by Microscope At Least 95% Coated	MIL-STD-883E

2.Environmental Endurance

No.	Test Item	Test Methods	CRITIREA	REF. DOC
2.1	Resistance To Soldering Heat	Pre-heat temperature 125 ℃ Pre-heat time 60 ~ 120 sec. Test temperature 260 ± 5 ℃ Test time 10 ± 1 sec. Times 3	△F/F<+/-5ppm △CI<+/-5 Ohm	MIL-STD-202F
2.2	High Temp. Storage	+ 125 ℃ ± 3 ℃ for 500 ± 12 hours	△F/F<+/-5ppm △CI<+/-5 Ohm	MIL-STD-883E
2.3	Low Temp. Storage	- 40 ℃ ± 3 ℃ for 500 ± 12 hours	△F/F<+/-5ppm △CI<+/-5 Ohm	
2.4	Thermal Shock	Total 100 cycles of the following temperature cycle  	△F/F<+/-5ppm △CI<+/-5 Ohm	MIL-STD-883E
2.5	High Temp＆Humidity	85℃ ± 3℃, RH 85% , 500Hrs	△F/F<+/-5ppm △CI<+/-5 Ohm	JIS C5023